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**sp3 Diamond Technologies Engages Adams Technical Sales  
as Sales Representative**

***Agreement Focused on sp3's CVD Diamond Products  
For Thermal Management Applications***

SANTA CLARA, Calif. — April 30, 2009 — [sp3 Diamond Technologies, Inc.](http://www.sp3diamond.com) (sp3), a leading supplier of diamond film products, equipment and services, today announced that Adams Technical Sales (ATS) has been engaged as a sales representative, and will be responsible for increasing sales of sp3's chemical vapor deposition (CVD) diamond products for thermal management applications. ATS will target prospective customers in Oregon, Idaho, Washington, Montana and British Columbia, Canada.

"Adams Technical Sales came highly recommended by customers in its selling territory," stated William Peifer, director of sales for sp3 Diamond Technologies. "ATS brings many years of solid experience in the semiconductor and component packaging markets to sp3, and we look forward to utilizing that experience to promote our diamond solutions."

ATS will be primarily responsible for marketing sp3's DiaTherm™ heat spreaders, diamond on silicon (DOS) wafers, silicon on diamond (SOD) wafers and diamond wafer coating services. The company specializes in the following markets: microwave, hermetic packaging, semiconductor, high power lasers, thick and thin film applications and component packaging applications for commercial, military and consumer uses.

Brent Adams, president of Adams Technical Sales, will have primary responsibility for representing sp3's thermal management portfolio to these markets. His professional experience includes sales, sales management and engineering consulting at leading companies. "ATS specializes in helping customers with unique engineering needs find a custom-fit solution," said Adams. "sp3's products provide new, cost-efficient solutions for the thermal management of devices, and will be an exciting addition to our current offerings."

**About sp3's CVD diamond products**

**DiaTherm** thick film CVD diamond heat spreaders exhibit exceptionally high thermal diffusivity and conductivity, making them ideal mounting structures for laser diodes, laser diode arrays, LEDs and high power semiconductor devices, including RF.

**Diamond on silicon (DOS)** wafers provide a uniform deposition of diamond on wafers of all sizes (up to and including 300 mm) leaving an exposed diamond surface for device developers, whether for active circuits or MEMS.

**Silicon on diamond (SOD)** wafers allow for a new level in thermal management: a thin layer of silicon is applied on top of the diamond layer, allowing the device manufacturer to work with a known interface (silicon) on a high thermally conductive substrate.

sp3's **wafer coating services** deliver a proven diamond CVD process to reach an ever-widening range of thermal management and diamond-on-silicon applications that can be deposited on wafers up to 300 mm.

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### **About sp3 Diamond Technologies, Inc.**

sp3 Diamond Technologies is focused on providing diamond-based solutions for electronics thermal management, diamond-on-silicon applications, and enhanced cutting surfaces. Based in Santa Clara, California, USA, the company provides diamond products for thermal and cutting applications, diamond deposition services, hot filament CVD reactors, and deposition consulting services to companies worldwide across a broad spectrum of industries.

sp3 Diamond Technologies is a subsidiary of sp3 Inc., a full service provider of products and services relating to thin-film and thick-film diamond deposition and other diamond materials. For more information about the company and its products and services please visit [www.sp3diamondtech.com](http://www.sp3diamondtech.com).